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# Advancing carrier transport models for InAs/GaSb type-II superlattice MWIR photodetectors

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In order to provide the best possible performance, modern infrared photodetector designs necessitate extremely precise modeling of the superlattice absorber region. We advance the Rode's method for the Boltzmann transport equation in conjunction with the **k.p** band structure and the envelope function approximation for a detailed computation of the carrier mobility and conductivity of layered type-II superlattice structures, using which, we unravel two crucial insights. First, the significance of both elastic and inelastic scattering mechanisms, particularly the influence of the interface roughness and polar optical phonon scattering mechanisms in technologically relevant superlattice structures. Second, that the structure-specific Hall mobility and Hall scattering factor reveals that temperature and carrier concentrations significantly affect the Hall scattering factor, which deviates significantly from unity even for small magnetic fields. This reinforces the caution that should be exercised when employing the Hall scattering factor in experimental estimations of drift mobilities and carrier concentrations. Our research hence offers a comprehensive microscopic understanding of carrier dynamics in such technologically relevant superlattices. Our models also provide highly accurate and precise transport parameters beyond the relaxation time approximation and thereby paving the way to develop physics-based device modules for mid-wavelength infrared photodetectors.

# I. INTRODUCTION

Modeling state-of-the-art infrared (IR) photodetectors [1–6] require highly accurate transport parameters for developing dark and photocurrent performance projections [5, 7–10]. Current technologically relevant IR photodetectors use III-V materials such as InAs/GaSb [11, 12] due to numerous advantages [13, 14]. Type-II superlattices (T2SLs) based on stacks of InAs/GaSb [1, 2, 14] are thus extensively used to design high-performance thirdgeneration IR detectors [15, 16]. Despite the fact that the mobility of the photogenerated minority carriers has a significant impact on the performance of IR photodetectors, carrier transport in technologically relevant T2SL structures has not as extensively been explored. Recent explorations in this context [17–23] which include carrier mobility calculations [24], do not conclusively bring to the fore structure-specific impact of important scattering mechanisms such as Piezoelectric (PZ), polar optical phonon (POP), acoustic deformation potential (ADP) scattering mechanisms and most importantly the interface roughness scattering (IRS).

With the necessity to develop a deeper understanding of carrier transport in technologically relevant T2SLs, this work advances an accurate model for transport calculations, wherein, we investigate different scattering limited transport under low-field in InAs/GaSb superlattices (SLs) as a function of free electron carrier concentration, temperature, and SL structural parameters. In our calculations, five primary scattering mechanisms that limit carrier mobility are the ionized impurity (II) [25], the PZ [26], the ADP [27], the POP and the IRS [28–31].

We advance the Rode's method [32–34] which goes beyond the relaxation time approximation (RTA) [35, 36], coupled with band structure calculations via the  $\mathbf{k}$ .p [37– 41] technique that also includes the strain effect due to lattice mismatch between InAs and GaSb materials [42]. We demonstrate the effect of both the elastic and the inelastic scattering mechanisms [43] on the electron mobility of the composite structure for a wide range of temperatures and doping concentrations. Our studies reveal that the low-temperature mobility of T2SLs is limited by the II, PZ and IRS scattering mechanisms. In contrast, the mobility at higher temperatures is mainly limited by the POP scattering mechanism, an inelastic and anisotropic process. At intermediate temperatures, however, the mobility decreases due to a combined effect of ADP and IRS mechanisms. The effects of several structural parameters including layer thicknesses, interface roughness heights, correlation lengths, and ion densities are thoroughly investigated. Our calculations thereby reinforce the superiority of the Rode's method [32, 34] over the conventionally employed RTA, wherein, the former is applicable over a wide temperature range in the presence of inelastic and anisotropic scattering mechanism.

In order to experimentally obtain the carrier concentration and drift mobility in a SL structure, it is also important to ascertain the Hall scattering factor, which is frequently thought of as being equal to unity, indicating that the Hall mobility and the drift mobility are equal. However, in many heterostructures, it differs significantly from unity, which results in inaccurate estimates of the carrier density and drift mobility. We clearly show that the temperature and carrier concentrations significantly affect the Hall scattering factor, and that it ranges from 0.3 to about 1.48 even for weak magnetic fields, thereby reinforcing that caution should be exercised when employing this factor in calculations involving drift mobil-

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ity and carrier concentration. The models developed here pave the way to develop physics-based device modules for mid-wavelength IR (MWIR) photodetectors.

This paper is structured as follows. In Sec. II we describe the  $\mathbf{k}.\mathbf{p}$  model to compute the band structure, electron distribution function, Boltzmann transport formalism, Rode's approach and various scattering processes. In Sec. III we illustrate the simulation methodology. In Sec. IV, we explain the findings and finally, in Sec. V, we summarize our results.

# II. ANALYTICAL FORMALISM

### A. Electronic band structure

The energy band structure of T2SLs can be calculated using various theoretical approaches like the density functional theory (DFT) [44], the empirical tightbinding method [35, 45, 46], the empirical pseudopotential method [47, 48], many-body perturbation theory [49] and the **k.p** perturbation method [37]. For this study, we use the **k.p** technique with the envelope function approximation (EFA) [24, 50, 51] since it overcomes the computational limitations of first-principles methods. The **k.p** model is extensively used because of its superiority in computing the energy band gap. Unlike ab - initio and tight binding methods, the **k.p** technique requires fewer input parameters I, with the related calculation procedure being straightforward.

In this work, we solve the 8-band Kane Hamiltonian [52], by perturbatively extending the wave function around high-symmetry points of the reciprocal space, employing the Lowdin's perturbation approach [52]. We also consider the spin-orbit coupling [53] in our computation, which provides additional contributions to the spin splitting of the energy bands [3]. The SL wavefunctions  $(\Phi_n(\mathbf{z}))$  in the orbital basis states  $(u_0(\mathbf{z}))$  along the growth direction (z) are articulated in terms of the slowly varying envelope functions  $(F(\mathbf{z}))$ , which are given as

$$\Phi_n(\mathbf{z}) = \sum_j F_j(\mathbf{z}) u_{j0}(\mathbf{z}).$$
(1)

Such envelope functions under the periodic boundary conditions can be rewritten as

$$F_j^i(\mathbf{k}, \mathbf{z}_0) = e^{-i\mathbf{a}d} F_j^i(\mathbf{k}, \mathbf{z}_M),$$
  

$$F_j^i(\mathbf{k}, \mathbf{z}_{M+1}) = e^{i\mathbf{a}d} F_j^i(\mathbf{k}, \mathbf{z}_1),$$
(2)

where, d denotes the thickness of a period, M represents the number of grid points, **a** denotes the Bloch vector of the envelope function that spans the Brillouin zone (BZ) and **k** represents the momentum along the transverse direction. The final Hamiltonian of the SL in the basis set comprises three matrices  $(H^0, H^I \text{ and } H^{II})$ , given by  $H(\mathbf{k}, k_z) = H^0 + H^I \left(-i\frac{\partial}{\partial z}\right) + \left(-i\frac{\partial}{\partial z}\right) H^{II} \left(-i\frac{\partial}{\partial z}\right)$ . The entire coupled differential equation is then solved using a numerical finite difference method [54], as described in earlier work [3].

The interface between the InAs and the GaSb layers is very abrupt as depicted in Fig. 1(a). The energy difference between the conduction band minimum (CBM) and the first heavy hole (HH) maximum at the center of the BZ determines the band gap in an InAs/GaSb-based T2SL, as shown in Fig. 1(b). Figure 1(b) also demonstrates that the InAs conduction band (CB) is lower than the GaSb valence band (VB), indicating that the band structure is a staggered T2SL [55].

### B. Carrier transport model

### 1. Boltzmann transport equation and its solution

In order to characterize the behavior of the T2SL system, we solve the Boltzmann transport equation (BTE) and compute the probability of finding a carrier with a crystal momentum k at a location r at a time t as indicated by the distribution function f(r, k, t). Solving the BTE (3) yields the average distribution of the carriers in both the position and the momentum space. The BTE can be written as [56–58]

$$\frac{\partial f}{\partial t} - \frac{\partial f}{\partial t}\Big|_{diff} - \frac{\partial f}{\partial t}\Big|_{forces} = \frac{\partial f}{\partial t}\Big|_{coll} + s(\mathbf{r}, \mathbf{p}, t) . \quad (3)$$

The term  $s(\mathbf{r}, \mathbf{p}, t)$ , in Eq. (3), represents generationrecombination processes [59], where p is the classical momentum. The term  $(\partial f/\partial t)_{forces}$ , represents the change in the distribution function due to applied electric and magnetic fields. The term  $(\partial f/\partial t)_{forces} = -\mathbf{F} \cdot \nabla_p f$ , where,  $\mathbf{F} = (d\mathbf{p}/dt) = \hbar (d\mathbf{k}/dt) = -e(\mathbf{E} + \mathbf{v} \times \mathbf{B})$ , represents the total force equal to the sum of the electric-force and the Lorentz-force owing to the magnetic flux density **B**, where e is the electron charge, **E** is the applied electric field and  $\mathbf{v}$  denotes the group velocity of the carriers. The term  $(\partial f/\partial t)_{diff} = -\mathbf{v} \cdot \nabla_r f$ , refers to the spatial change in the distribution function caused by temperature or concentration gradients, which results in carrier diffusion in the coordinate space. Here,  $(\partial f/\partial t)_{coll}$  is the collision term, which indicates how the distribution function changes over time due to collision events, and can be described as the difference between the in- and the out-scattering processes, i.e.,

$$\left(\frac{\partial f}{\partial t}\right)_{coll} = \sum_{\mathbf{k}_{1}} \left\{ S(\mathbf{k}_{1}, \mathbf{k}) f(\mathbf{k}_{1}) \left[\mathbf{1} - f(\mathbf{k})\right] - S(\mathbf{k}, \mathbf{k}_{1}) f(\mathbf{k}) \left[\mathbf{1} - f(\mathbf{k}_{1})\right] \right\},$$
(4)

where,  $S(\mathbf{k}, \mathbf{k}_1)$  and  $S(\mathbf{k}_1, \mathbf{k})$  are the transition rates for an electron moving between states  $\mathbf{k}$  and  $\mathbf{k}_1$ . Under steady-state,  $\frac{\partial f}{\partial t} = 0$ , in case of spatial homogeneity,  $\nabla_r f = 0$ , and assuming that there is no recombination-



FIG. 1. Preliminaries. (a) Schematic of InAs/GaSb based T2SL structure. The electron wave function in the InAs layer extends beyond the interface into the GaSb layer and overlaps with the heavy hole wave function. Here, nML and mML are the numbers of monolayers of InAs and GaSb respectively, in a single period d. (b) Band alignment of InAs/GaSb based T2SL system showing the optical transition between the heavy-hole valence miniband and the electrons from lowest conduction minibands that is employed to detect IR radiation. The periodic potential of the d period emerges in the material due to the modulation of the semiconductor layers. The creation of hole (electron) minibands in the valence (conduction) band is caused by the overlap of hole (electron) wave functions between adjacent GaSb (InAs) layers. The difference between the first electron miniband in the CB and the first heavy hole miniband in the valence band is used to compute the effective bandgap energy  $E_g$  of the T2SL (highlighted in black).

generation term, the BTE (3) can be rewritten as

$$-\frac{e\mathbf{E}}{\hbar} \cdot \nabla_k f = \sum_{\mathbf{k_1}} \left\{ S(\mathbf{k_1}, \mathbf{k}) f(\mathbf{k_1}) \left[ \mathbf{1} - f(\mathbf{k}) \right] - S(\mathbf{k}, \mathbf{k_1}) f(\mathbf{k}) \left[ \mathbf{1} - f(\mathbf{k_1}) \right] \right\}.$$
(5)

In the low-electric field regime, the distribution function can be represented as [60]

$$f(\mathbf{k}) = f_0 \Big[ \varepsilon(k) \Big] + g(k) \cos \theta , \qquad (6)$$

where,  $k=|\mathbf{k}|$ , f denotes the actual electron distribution function, which includes both the elastic and the inelastic scattering mechanisms, g(k) is the perturbation term to  $f_0[\varepsilon(k)]$  produced by the electric field,  $\theta$  is the angle between applied electric field (along the symmetry axis) and the electron wave vector  $\mathbf{k}$ , and  $f_0$  represents the distribution function under equilibrium conditions, which is taken according to Fermi-Dirac statistics [35, 59]. By solving Eqs. (5) and (6), the perturbation term g(k), can be calculated as [32, 34, 61, 62]

$$g_i(k) = \left[\frac{S_i\left[g_i(k)\right] - \frac{(-e)E}{\hbar}\left[\frac{\partial f_o}{\partial k}\right]}{S_o(k) + \frac{1}{\tau_{el}(k)}}\right],\tag{7}$$



FIG. 2. The various dominant scattering mechanisms involved in a T2SL structure.

where  $E = |\mathbf{E}|$ , and  $g_i(k)$  appears on both sides of Eq. (7). Hence, we solve Eq. (7) iteratively and the convergence is exponentially fast which takes a few iterations. Once  $g_i(k)$  is obtained, we calculate the mobility. In Eq. (7), the term *i* indicates the iteration index, and the terms,  $S_i \& S_o$  are the in-scattering and the out-scattering operators, respectively, for inelastic scattering mechanisms, as explained in Sec. II B. The term  $\frac{1}{\tau_{el}(k)}$ , represents the total momentum relaxation rate of all the elastic scattering mechanisms, which is calculated according to the Matthiessen's rule (8), and can be written as

## 2. Ionized impurity scattering

 $\frac{1}{\tau_{_{el}}(k)} = \frac{1}{\tau_{_{II}}(k)} + \frac{1}{\tau_{_{PZ}}(k)} + \frac{1}{\tau_{_{ADP}}(k)} + \frac{1}{\tau_{_{IRS}}(k)} . \quad (8) \qquad (8)$ 

The various dominant scattering mechanisms involved in an InAs/GaSb-based T2SL structure are shown in Fig. 2. The II scattering mechanism [25] arises due to the Coulomb interactions between electrons and ions, when a charged center is introduced inside the bulk material. The II scattering mechanism is entirely elastic and dominates usually at high doping concentrations and low temperatures. The II scattering mechanism dominates near the CB edge but reduces drastically as the energy increases [63]. The scattering rate for the II increases rapidly with decreasing temperature. Here, we use the Brooks-Herring approach [64] for the calculation of II scattering rate [34, 65], which is given by

$$\frac{1}{\tau_{II}(k)} = \frac{e^4 N}{8\pi \nu(k) (\epsilon_0 \epsilon_s)^2 (\hbar k)^2} \left[ P(k) \ln\left[1 + 4\left(\frac{k}{\beta}\right)^2\right] - Q(k) \right],\tag{9}$$

where,  $\epsilon_0$  is the permittivity of the free space,  $\epsilon_s$  is the static dielectric constant,  $\hbar$  is the reduced Planck's constant and N is the ionized impurity concentration, which is the sum of the acceptor and donor impurity concentration i.e.,  $N = N_A + N_D$ . Here,  $\beta$  indicates the inverse screening length, which is given as

$$\beta = \sqrt{\frac{e^2}{\epsilon_0 \epsilon_s k_B T} \int D_S(\varepsilon) f_0(1 - f_0) d\varepsilon} , \qquad (10)$$

where,  $D_S(\varepsilon)$  is the density of states (DOS) at energy  $\varepsilon$ and  $k_B$  is the Boltzmann constant. P(k) and Q(k) can be expressed as follows [34, 62]

$$P(k) = \left[\frac{3}{4} \left(\frac{\beta c(k)}{k}\right)^4 + 2\left(\frac{\beta c(k)}{k}\right)^2 + 1\right], \qquad (11)$$

$$Q(k) = \left[\frac{3\beta^4 + 6\beta^2 k^2 - 8k^4}{(\beta^2 + 4k^2)k^2}\right]c^4(k) + 8\left[\frac{\beta^2 + 2k^2}{\beta^2 + 4k^2}\right]c^2(k) + \left[\frac{4\left(k/\beta\right)^2}{1 + 4\left(k/\beta\right)^2}\right].$$
(12)

The detailed explanation of the P and Q parameters are given in the literature [34]. Here, the wave function admixture c(k) represents the contribution of the p-orbital to the wave function of the band.

### 3. Piezoelectric scattering

The PZ effect arises due to the acoustic phonon scattering in polar semiconductors. Being a weak effect, the PZ scattering is elastic and significant only at low doping concentrations and low temperatures, where other scattering mechanisms are weak. The momentum relaxation rate for the PZ scattering is given by [32, 65]

$$\frac{1}{\tau_{PZ}(k)} = \frac{(eP)^2 k_B T}{6\pi \epsilon_0 \epsilon_s \nu(k) \hbar^2} \Big[ 4c^4(k) - 6c^2(k) + 3 \Big] , \quad (13)$$

where, P is a piezoelectric coefficient, which is a dimensionless quantity. For the zincblende structure, it is given as [34, 62]

$$P^{2} = \frac{h_{14}^{2} \epsilon_{0} \epsilon_{s}}{35} \left[ \left( \frac{12}{c_{l}} \right) + \left( \frac{16}{c_{t}} \right) \right], \qquad (14)$$

where,  $h_{14}$  is an element of the PZ stress tensor, and  $c_t$  and  $c_l$  represents the spherically averaged elastic constants for transverse and longitudinal modes, respectively, and are given by [26, 32, 34]

$$c_{l} = \frac{3}{5}c_{11} + \frac{1}{5}\left(2c_{12} + 4c_{44}\right),$$
  

$$c_{t} = \frac{1}{5}\left(c_{11} - c_{12}\right) + \frac{3}{5}c_{44},$$
(15)

where  $c_{11}$ ,  $c_{12}$ , and  $c_{44}$  are three independent elastic constants.

### 4. Acoustic deformation potential scattering

The ADP scattering mechanism is caused by the interaction of electrons with non-polar acoustic phonons. It is approximately elastic near room temperature For the ADP scattering mechanism, the momentum relaxation rate is given by [34, 65]

$$\frac{1}{\tau_{_{ADP}}(k)} = \frac{k_B T \left(e \Xi_D k\right)^2}{3\pi c_{el} \nu(k) \hbar^2} \Big[ 6 c^4(k) - 8 c^2(k) + 3 \Big], \quad (16)$$

where,  $c_{el}$  denotes the spherically averaged elastic constant and  $\Xi_D$  represents the acoustic deformation potential, which is obtained by the CB shift (in eV) per unit strain, owing to the acoustic waves(17). To calculate the acoustic deformation potential ( $\Xi_D$ ), we use the following relation (17)

$$\Xi_D = -V \times \left(\frac{\partial E_{CBM}}{\partial V}\right)\Big|_{V=V_0}, \qquad (17)$$

where, V denotes the volume,  $E_{CBM}$  represents the energy of the CBM and  $V_0$  is the zero pressure volume of the structure.

### 5. Interface roughness scattering

The existence of the interface roughness in a T2SL [17, 18, 23, 29, 66] structure leads to endemic variations in InAs well widths, causes modulation of the associated energy levels and introduces an unstable potential for the motion of the confined electrons. The IRS mechanism can occur due to the imperfections that arise during the growth of the material. The earlier related works [67, 68] show that the degree of scattering decreases in proportion to the well width hence it is important in MWIR detectors. The IRS mechanism is an elastic process and dominates at low temperatures in thin-film systems for a short period of T2SL, and it is significant at high electron density. The momentum relaxation rate for the IRS mechanism is given as [57, 69, 70]

$$\frac{1}{\tau_{IRS}(k)} = \left(\frac{e^2 \Delta \Lambda}{\epsilon_0 \epsilon_\infty}\right)^2 \frac{k}{\hbar^2 \nu(k)} \left(N_d + \frac{N_s}{2}\right)^2 \times \frac{1}{\sqrt{1 + (k\Lambda)^2}} \varepsilon \left(\frac{k\Lambda}{\sqrt{1 + (k\Lambda)^2}}\right),$$
(18)

where,  $\Lambda$  is the lateral correlation length,  $\Delta$  is the roughness height,  $N_s$  is the sheet carrier concentration, and  $N_d$  is the doping carrier density.

### 6. Polar optical phonon scattering

The POP scattering results from the interaction of optical phonons with electrons. The POP scattering mechanism is inelastic and anisotropic, which occurs via the emission or the absorption of a phonon hence, RTA is inapplicable in such SL structures. The scattering rate due to the POP scattering mechanism is approximately constant at very high energies, and it depends on the POP frequencies. The POP scattering dominates in the higher temperature domain. Hence, it is significant at both near and beyond room temperature. The out-scattering operator is given by [34]

$$S_{o} = \left(N_{pop} + 1 - f^{-}\right)\lambda_{o}^{-} + \left(N_{pop} + f^{+}\right)\lambda_{o}^{+}, \quad (19)$$

$$\lambda_{o}^{\pm} = L^{\pm} \left[ (A^{\pm})^{2} ln \left| \frac{k^{\pm} + k}{k^{\pm} - k} \right| - A^{\pm} cc^{\pm} - aca^{\pm} c^{\pm} \right], \quad (20)$$

$$L^{\pm} = \frac{e^2 \,\omega_{pop} \,k^{\pm}}{4\pi \,\hbar \,k \,\nu(k^{\pm})} \Big(\frac{\epsilon_s - \epsilon_\infty}{\epsilon_s \,\epsilon_\infty}\Big),\tag{21}$$

where,  $\epsilon_{\infty}$  and  $\epsilon_s$  are high and low-frequency dielectric constants, respectively.

$$A^{\pm} = aa^{\pm} + \left[ (k^{\pm})^2 + k^2 \right] cc^{\pm} / 2 k^{\pm} k , \qquad (22)$$

where c,  $c^{\pm}$ , a and  $a^{\pm}$  are the wave function coefficients,  $k^{\pm}$  is the solution of Eq.  $\varepsilon(k) \pm \hbar \omega_{pop}$ . Any quantity superfixed by plus/minus is to be evaluated at the energy corresponding to  $k^+$  or  $k^-$ . The superscript plus denotes scattering by the absorption and is evaluated at an energy  $\varepsilon(k) + \hbar \omega_{pop}$ . Similarly, superscript minus denotes scattering by the emission and is evaluated at energy  $\varepsilon(k) - \hbar \omega_{pop}$ . Emission of phonons is possible only if the phonons' energy is greater than  $\hbar \omega_{pop}$  energy. Therefore, if the phonon energy is less than  $\hbar \omega_{pop}$ , the term  $\lambda_{o}^{-}$ has to be considered as zero. The term  $N_{pop}$ , indicates the number of optical phonons and is given by the Bose distribution as [32, 34]

$$N_{pop} = \frac{1}{\exp\left(\hbar \,\omega_{pop} \,/ \,k_B \,T\right) \,-\, 1} \,. \tag{23}$$

The in-scattering operator  $S_i$ , is given by

$$S_i = (N_{pop} + 1 - f)\lambda_i^+ g^+ + (N_{pop} + f)\lambda_i^- g^-, \quad (24)$$

where, plus and minus superscripts indicate the absorption and emission processes, respectively. The term  $\lambda_i^{\pm}(k)$  can be expressed as

$$\lambda_{i}^{\pm}(k) = L^{\pm} \left[ \frac{(k^{\pm})^{2} + k^{2}}{2 k^{\pm} k} (A^{\pm})^{2} ln \left| \frac{k^{\pm} + k}{k^{\pm} - k} \right| - (A^{\pm})^{2} - \frac{c^{2}(k) (c^{\pm}(k))^{2}}{3} \right].$$
(25)

The mobility can be calculated after calculating the rates of all the elastic scattering mechanisms  $\frac{1}{\tau_{el}(k)}$  (8) and the influence of inelastic scattering mechanisms on g (7) through the terms  $S_i(g)$  (24) and  $S_o$  (19). The rates of various elastic scattering mechanisms are calculated by using the expressions given in Eqs. (9), (13), (16), (18).

## C. Mobility and conductivity

The RTA [56] cannot be used if the scattering process is inelastic and anisotropic because there is no way to define the relaxation time that is independent of the distribution function. In such instances, Rode's iterative approach can be applied to compute the real distribution function under low-field conditions. After calculating the perturbation distribution by using Rode's algorithm, we finally calculate the low-field carrier mobility,



FIG. 3. Flowchart for the calculation of electronic transport parameters.

 $\mu$  [32, 34, 65]

$$\mu = \frac{1}{3E} \frac{\int \nu(\varepsilon) D_S(\varepsilon) g(\varepsilon) d\varepsilon}{\int D_S(\varepsilon) f_0(\varepsilon) d\varepsilon} .$$
(26)

The term  $g(\varepsilon)$ , can be obtained from Eq. (7) and the carrier velocity  $\nu(\mathbf{k})$  can be calculated from the band structure as

$$\nu(\mathbf{k}) = \frac{1}{\hbar} \frac{\partial \varepsilon}{\partial \mathbf{k}} \,. \tag{27}$$

Once the mobility is determined, it is pretty easy to calculate the electrical conductivity by using

$$\sigma = n \, e \, \mu \,, \tag{28}$$

where,  $\mu$  is the electron drift mobility, and n is the electron carrier concentration. The entire sequence for calculating the transport coefficients using Rode's approach is shown in Fig. 3.

Similarly, in the presence of an arbitrary magnetic field, the BTE can be solved. The distribution function in such cases can be written as [33, 71]

$$f(\mathbf{k}) = f_0[\varepsilon(k)] + xg(k) + yh(k) , \qquad (29)$$

where, y is the direction, cosine from  $\mathbf{B} \times \mathbf{E}$  to  $\mathbf{k}$ , and h(k) is the perturbation distribution function due to the magnetic field. Substituting Eq. (29) in (3) gives a pair of coupled equations that can be solved iteratively [33]

$$g_{i+1}(k) = \frac{S_i(g_i(k) - \frac{(-e)E}{\hbar} \left(\frac{\partial f_0}{\partial k}\right) + \beta S_i(h_i(k))}{S_o(k) \left(1 + \beta^2\right)}, \quad (30)$$

$$h_{i+1}(k) = \frac{S_i(h_i(k) + \beta \frac{(-e)E}{\hbar} \left(\frac{\partial f_0}{\partial k}\right) - \beta S_i(g_i(k))}{S_o(k) \left(1 + \beta^2\right)}, \quad (31)$$

where,  $\beta = \frac{(-e)\nu(k)B}{\hbar k S_o(k)}$ , and *B* is the applied magnetic field. The expression for the Hall mobility and the Hall scattering factor can be written as [60]

$$\mu_{H} = \frac{1}{B} \frac{\int \nu(\varepsilon) D_{S}(\varepsilon) h(\varepsilon) d\varepsilon}{\int \nu(\varepsilon) D_{S}(\varepsilon) g(\varepsilon) d\varepsilon}, \qquad (32)$$

$$r_{H} = \frac{\mu_{H}}{\mu} , \qquad (33)$$

where,  $\mu_H$  and  $\mu$  are the Hall and the drift mobility, respectively, and  $r_H$  is the Hall scattering factor. This solution gives a more accurate result for the Hall scattering factor compared with the other expressions based on the RTA [71].

# **III. SIMULATION APPROACH**

First, we calculate the band structure using the **k.p** technique as discussed in Sec. II A and then analytically fit it to produce a smooth curve for the calculation of group velocity [62]. By using Eq. (34), the Fermi level is determined with a smooth band structure obtained after the analytical fitting, where  $V_0$  represents the volume of the cell and  $\varepsilon_c$  represents the energy at the bottom of the CB.

$$n = \frac{1}{V_0} \int_{\varepsilon_c}^{\infty} D_S(\varepsilon) f(\varepsilon) d\varepsilon .$$
 (34)

Equations (9), (13), (16), (18), (19), (24) are used to calculate the various scattering rates, and the perturbation in the distribution function is determined using Eq. (7) with  $S_i(k) = 0$ . The term g(k), is calculated iteratively until g(k) converges and it gives results beyond the RTA.

# IV. RESULTS AND DISCUSSION

### A. Dispersion relation for T2SL

We calculate the band structure of an InAs/GaSbbased T2SL, with layer widths nML/mML, where n, m = 8, 8 correspondingly, using the  $8 \times 8$  **k.p** technique as described in Sec. II A, at a temperature of T=77 K, and the results are shown in Fig. 4. In a single period of 8ML/8ML InAs/GaSb configuration, the thickness of

Unit	InAs	GaSb
Å	6.0584	6.0959
-	0.022	0.0412
eV	0.418	0.814
-	19.4	11.84
-	8.545	4.25
-	9.17	5.01
meV/K	0.276	0.417
K	93	140
eV	21.5	22.4
eV	0.38	0.76
eV	-0.56	0
	Unit Ä - eV - - meV/K K eV eV eV eV	$\begin{tabular}{ c c c c } \hline Unit & InAs \\ \hline Å & 6.0584 \\ - & 0.022 \\ eV & 0.418 \\ - & 19.4 \\ - & 8.545 \\ - & 9.17 \\ meV/K & 0.276 \\ K & 93 \\ eV & 21.5 \\ eV & 0.38 \\ eV & -0.56 \\ \hline \end{tabular}$

TABLE I. Material parameters required to calculate the electronic band structure using the  $\mathbf{k}.\mathbf{p}$  technique at T = 77 K [37, 72–74]



FIG. 4. Calculated band structure in the first BZ using the periodic boundary condition of a T2SL based on 8 ML InAs / 8 ML GaSb at T = 77 K using the **k.p** method (a) The in-plane dispersion and (b) the out-of-plane dispersion.



FIG. 5. DOS calculated using the  $\mathbf{k.p}$  method in an InAs/GaSb SL as a function of energy. The inset clearly shows how the DOS for the carriers in the VB varies as a function of energy.

each layer is roughly 24 Å. The dispersion curve along the in-plane and the out-of-plane directions are presented in Figs. 4(a) and 4(b), respectively and the calculated band

gap is 270 meV. The band gap of 270 meV corresponds to a cut-off wavelength of 4.59  $\mu$ m which confirms that our model is best suited for the MWIR spectrum. In Fig. 5 we show the DOS of an SL as a function of energy, calculated using the **k.p** method. Table I summarizes the values of the parameters, utilized in the **k.p** calculations.

### B. Scattering rates

In Fig. 6, we show the dependence of scattering rates with energy for the temperatures of 77 K, 300 K, and 500 K at doping densities of  $N_D = 1 \times 10^{13} \ cm^{-3}$ and  $N_D = 2 \times 10^{17} \ cm^{-3}$ . Here, we show the relative importance of each of the scattering mechanisms in a T2SL. The IRS mechanism is the strongest scattering mechanism for low as well as high doping densities at a temperature of 77 K and 300 K as shown in Fig. 6. At a temperature of 77 K and a doping density of  $N_D = 1 \times 10^{13} \ cm^{-3}$ , the most dominant contributions are due to the IRS followed by the ADP and the POP scattering mechanisms. The II scattering mechanism is the least significant scattering mechanism at this particular temperature and doping density, whereas it has a significant contribution at higher doping densities.

At room temperature, the average energy of the carriers is  $3/2k_BT = 0.0388 \ eV$ , indicating that the majority of the carriers are in the low-energy region. Hence, it is clear from Fig. 6(e) that at room temperature, the significant contribution comes from the IRS mechanism as well as the POP scattering mechanism. Both scattering mechanisms are dominant at this temperature, and the dominance of the POP scattering mechanism changes with respect to temperature and the average energy of the carriers, which signifies that the POP scattering mechanism plays a significant role in such a T2SL structure. As a result, it is important to note that the POP scattering mechanism is the primary factor limiting the carrier's mobility from room temperature to higher temperatures.

At a temperature of 500 K, the average energy of the carriers is  $0.0646 \ eV$  and, most of the carrier contributes to the POP scattering mechanism hence, this



FIG. 6. Scattering rates for 8ML/8ML InAs/GaSb based T2SL with roughness parameters  $\Lambda = 3 nm$  and  $\Delta = 0.3 nm$  as a function of electron energy at (a) T = 77 K and  $N_D = 1 \times 10^{13} cm^{-3}$  (b) T = 300 K and  $N_D = 1 \times 10^{13} cm^{-3}$  (c) T = 500 K and  $N_D = 1 \times 10^{13} cm^{-3}$  (d) T = 77 K and  $N_D = 2 \times 10^{17} cm^{-3}$  (e) T = 300 K and  $N_D = 2 \times 10^{17} cm^{-3}$  and (f) T = 500 K and  $N_D = 2 \times 10^{17} cm^{-3}$ .

TABLE II. Material parameters required to compute the various scattering rates [32, 73, 75–78].

Parameter	$\mathbf{Unit}$	InAs	GaSb
Elastic constant $c_{11}$	GPa	832.9	884.2
Elastic constant $c_{12}$	GPa	452.6	402.6
Elastic constant $c_{44}$	GPa	395.9	432.2
Acoustic deformation potential	${ m eV}$	4.90	6.70
Low freq. dielectric constant	-	14.55	15.00
High freq. dielectric constant	-	11.78	13.80
Piezoelectric coefficient	$C/m^2$	0.045	0.126
Optical phonon frequency	1/cm	240 (LO) <sup>a</sup> , 218 (TO) <sup>b</sup>	193 (LO) <sup>a</sup> , 215 (TO) <sup>b</sup>

<sup>a</sup> LO : Longitudinal Optical Phonon Frequency.

 $^{\rm b}$  TO : Transverse Optical Phonon Frequency.

again demonstrates that the POP scattering mechanism is the most dominant scattering mechanism for T2SL at and beyond the ambient temperature for both doping densities, as shown in Figs. 6(c) and 6(f). Figure 6 shows a sudden change in the POP scattering rate after particular energy, which is because if the electron energy is less than the POP energy, the electron can only scatter by the absorption of the optical phonons, whereas if the energy is greater than the phonon energy, the electron can scatter by both the absorption and the emission of phonons, where the optical phonon energy is determined using  $\hbar \omega_{POP}$ . The PZ scattering is the least dominant scattering mechanism at higher doping densities, as shown in Figs. 6(d), 6(e), 6(f). Table II lists the material parameters that are used to compute the various scattering rates.

It is generally known that the ADP scattering mechanism becomes substantial at temperatures of 77 K and above, reducing electron mobility. Therefore, it is also important to include the effect of the ADP scattering mechanism, which is significant near the room temperature for low as well as high doping densities, which was



FIG. 7. Calculated mobility contribution for electrons due to the various scattering mechanism involved in (8ML/8ML) InAs/GaSb T2SL as a function of temperature for  $N_D = 9 \times 10^{16} \text{ cm}^{-3}$ .



FIG. 8. Calculated low-field electron drift mobility in 8ML/8ML InAs/GaSb SL as a function of doping concentration for temperatures of 77 K, 120 K and 150 K.

not highlighted in the earlier works for such SL structures. At lower temperatures and in the thin-film systems, the IRS scattering is considerable, and to compute the roughness scattering rate, we utilize a sheet carrier density  $N_s$ , of  $4.6 \times 10^{12} \ cm^{-2}$  and a doping carrier density  $N_d$ , of  $1 \times 10^{11} \ cm^{-2}$  with the roughness height  $\Delta$ , fixed at  $0.3 \ nm$ , and the correlation length of the fluctuations  $\Lambda$  kept at 3 nm. The IRS mechanism is temperature independent, but the carrier distribution function depends on the temperature. Therefore, the electron mobility through the IRS mechanism is somewhat temperature sensitive. Except for the IRS scattering rate, which is temperature independent, we see that all the scattering rates increase as the temperature rises as shown in Figs. 6(a), 6(b), 6(c). When the temperature is either low or intermediate, the II scattering rate increases with an increase in the doping concentration, which suppress the contribution from the PZ scattering, as shown in Figs. 6(a), 6(d), 6(b), 6(e).



FIG. 9. Comparison of conductivity in a T2SL as a function of temperature, calculated using the Rode's and the RTA method for various doping concentrations.



FIG. 10. Calculated temperature dependence of electronic mobility with IRS heights for a correlation length of 3 nm &  $N_D = 9 \times 10^{16} \text{ cm}^{-3}$ . The mobility due to only the IRS mechanism is shown.

### C. Electron transport parameters

We calculate the mobility and the conductivity for a T2SL at various temperatures and doping concentrations. Figure 7 shows the contribution to the mobility due to various scattering mechanisms calculated for  $N_D = 9 \times 10^{16} \text{ cm}^{-3}$ . To the best of our knowledge, the combined effect of these scattering mechanisms in a T2SL structure has never been shown in earlier works. These five types of scattering mechanisms show their significant contribution to the overall mobility calculation. From Fig. 7 it turns out that the scattering mechanism with the lowest mobility values is the dominant one in that temperature range. Therefore, starting at a temperature of 150 K, the POP scattering mechanism is the most dominant scattering mechanism until 700 K; below 77 K, a significant contribution to the mobility comes from the II scattering and the IRS mechanisms as shown



FIG. 11. Calculated mobility for electrons in an 8ML InAs/8ML GaSb SL as a function of temperature and correlation length for an IRS height of 0.3 nm with  $N_D = 9 \times 10^{16} \text{ cm}^{-3}$ . Here, the mobility due to only the IRS mechanism is shown.



FIG. 12. Temperature dependence of electron Hall mobility in a T2SL calculated using the Rode's and the RTA method at B = 0.69 T for various doping concentrations.

in Fig. 7.

In case of II scattering mechanism, with increasing temperature, the electron density increases exponentially and causes growth in the screening length. As a result, the mobility at low temperatures increases sharply with rising temperatures because the scattering rates are inversely related to the square of the screening length. Since the POP scattering mechanism is more prominent above 150 K; hence the overall mobility is reduced as shown in Fig. 7. In Fig. 7, we also compare the mobility computed using the RTA approach to the overall mobility calculated using Rode's method and it is found that in the RTA approach, the mobility is underestimated because the POP scattering mechanism is inelastic and nonrandomizing, making it impossible to characterize the perturbation in the distribution function using the relax-



FIG. 13. Hall scattering factor versus temperature at B= 0.69 T for  $N_D = 9 \times 10^{17} cm^{-3}$ .



FIG. 14. Hall scattering factor as a function of temperature and carrier concentration at B = 0.69 T.

ation time. The POP scattering mechanism becomes insignificant at low temperatures, resulting in nearly comparable mobilities determined using the RTA and Rode's iterative technique.

In Fig. 8, we demonstrate the overall mobility versus doping concentration at different temperatures and emphasize on the mobility at 77K, which is the usual operating temperature of most high-performance IR detectors. The graph illustrates a decrease in mobility as the doping concentration increases due to a rise in the number of ionized centers. As we raise the temperature, the mobility diminishes as expected because at higher temperatures the phonon scattering increases. The mobility values do not differ significantly for low carrier concentrations because the II scattering mechanism is less significant at this range and the primary contributions for lower doping concentration at low temperatures come from the PZ and the ADP scattering mechanisms, while at greater doping concentrations, the II scattering mechanism is comparable to the ADP and the PZ scattering mechanisms. The mobility owing to the II scattering mechanism is a decreasing function of  $N_D$ , the mobility begins to decrease as  $N_D$  exceeds  $1 \times 10^{16} \ cm^{-3}$ .

In Fig. 9, we show the conductivity versus temperature for the doping concentrations of  $N_D = 1 \times 10^{13} \text{ cm}^{-3}$ ,  $N_D = 1 \times 10^{16} \text{ cm}^{-3}$  and  $N_D = 9 \times 10^{16} \text{ cm}^{-3}$ , respectively, and to demonstrate the supremacy of our approach, we compare the results obtained using both the Rode's and the RTA method. At higher temperatures, the difference in the result of Rode's method and the RTA is due to the POP scattering mechanism, the POP scattering is weaker at lower temperatures hence both the RTA and the Rode exhibit the same conductivity. We demonstrate that the conductivity in a T2SL increases with an increase in the carrier concentration but decreases as we increase the temperature.

In Figs. 10 and 11, we show the mobility due to only the IRS mechanism. The calculated mobilities are vital functions of the roughness parameters and the carrier scattering. The existing mobility calculations reveal that, up to temperatures where the POP scattering mechanism takes over, the IRS is the dominating scattering mechanism in T2SL. The screening is included in our calculation using Thomas-Fermi screening which lowers the scattering rates and increases the mobility. As illustrated in Fig. 10, the mobility is shown to be strongly reliant on the roughness height  $\Delta$ , and decreases monotonically with increasing  $\Delta$ , and is proportional to  $\Delta^{-2}$ .

Figures 10 and 11 show that at low temperatures, the mobility rises since the value of  $\frac{\partial f}{\partial \varepsilon}$  is an ascending function of temperature and the denominator of Eq. (26) is virtually constant at lower temperatures. Also, the electron density increases at higher temperatures and hence the mobility drop smoothly. Figure 11 shows that the mobility is high for smaller values of correlation length  $\Lambda$ , and drops rapidly as the correlation length of roughness increases until it reaches a saturation point. The mobility reaches its maximum value at roughly 50 K for smaller values of  $\Lambda$ , and this maximum point moves toward the higher temperatures for greater values of  $\Lambda$ .

The Hall mobility in InAs/GaSb T2SLs is depicted in Fig. 12. At temperatures above 50 K, the mobility reduces as expected from a combination of the ADP and the POP scattering mechanisms. In T2SL, the mobility increases with decreasing temperature, preferable to the  $T^{-3/2}$  dependency associated with the phonon scattering. The greater temperature dependency of the electron mobility in InAs/GaSb-based T2SL may indicate stronger electron-phonon coupling than in the bulk material. The increased mobility near 50 K could be attributed to a longer scattering time or a lower electron-effective mass at the CB edge.

When the Hall scattering factor  $r_{\rm H}$ , deviates significantly from unity, it indicates that to derive the electron drift mobility from the experimentally calculated Hall mobility data, the Hall scattering factor must be precisely determined. Figure 13 shows the predicted values of the Hall scattering factor against the temperature at  $B = 0.69 \ T$  for  $N_D = 9 \times 10^{17} \ cm^{-3}$ , while Fig. 14

depicts the Hall scattering factor as a function of temperature and the carrier concentration at B = 0.69 T.

To the best of our knowledge, calculations of the Hall scattering factor in such SLs have not been performed yet in earlier works. The contribution of various scattering mechanisms decides the Hall scattering factor's value. Figures 13 and 14 indicate that the value of  $r_{\mu}$  at low temperatures deviates significantly from unity, while many researchers use one as an ideal value for a variety of calculations and studies, which is not accurate. The carrier concentration and the drift mobility may both be overestimated and underestimated when the Hall scattering factor is used as unity. The Hall scattering factor, in our calculation, fluctuates between the values as low as 0.3 at low temperature and electron concentration, and as high as 1.48 and even more at high temperature and electron concentration as shown in Fig. 14. Therefore, it is worth pointing out that, while evaluating the carrier concentration and the drift mobility in such SLs, one must use caution.

In this work, we calculate the precise values of the Hall scattering factor and show that for a doping value of  $N_D = 9 \times 10^{17} \ cm^{-3}$ , the computed values of  $r_H$  are  $0.914,\ 0.952$  and 1.01 at temperatures of 77 K, 150 K and 190 K, respectively, as also depicted in Fig. 13. At higher temperatures, the value of the Hall scattering factor is more than unity, indicating that the drift mobility is lower than the Hall mobility, implying that the phonon-assisted scattering mechanisms are substantial and diminish the drift mobility. As shown in Fig. 14, at temperatures of 30 K and 77 K, the Hall scattering factor is equal to 0.335 & 0.638 for lower doping concentrations of  $N_D = 1 \times 10^{12} \text{ cm}^{-3}$  and it is equal to 0.369 & 0.691 with slightly higher doping concentrations of  $N_D = 5 \times 10^{15} \ cm^{-3}$  which signifies that the Hall scattering factor increases as the temperature and electron concentrations rise, but as we increase the carrier concentration beyond  $3 \times 10^{17} \ cm^{-3}$ , the Hall scattering factor starts decreasing. The higher electron concentration causes a rapid variation in the Hall factor.

# V. CONCLUSION

In this paper, we developed the Rode algorithm on the BTE in conjunction with the  $\mathbf{k}.\mathbf{p}$  band structure and the EFA for a detailed computation of the carrier mobility and conductivity, in order to primarily unravel two crucial insights. First, the significance of both elastic and inelastic scattering mechanisms, particularly the influence of the IRS and POP scattering mechanisms in technologically relevant SL structures. Second, the structure specific Hall mobility and Hall scattering factor, which reveals that temperature and carrier concentrations significantly affect the Hall scattering factor, which deviates significantly from unity, i.e., from 0.3 to about 1.48, even for small magnetic fields. This reinforces the caution that should be exercised when employing the Hall

scattering factor in experimental estimations of drift mobilities and carrier concentrations. Our research offers a comprehensive microscopic understanding of carrier dynamics in such technologically relevant SLs. Our model also provides highly accurate and precise transport parameters beyond the RTA and hence paves the way to develop physics based device modules for MWIR pho-

- D. Smith and C. Mailhiot, Journal of Applied Physics 62, 2545 (1987).
- [2] A. Rogalski, P. Martyniuk, and M. Kopytko, Applied physics reviews 4, 031304 (2017).
- [3] S. Mukherjee, A. Singh, A. Bodhankar, and B. Muralidharan, Journal of Physics D: Applied Physics 54, 345104 (2021).
- [4] A. Rogalski, *Infrared detectors* (CRC press, 2000).
- [5] A. Dehzangi, J. Li, and M. Razeghi, Light: Science & Applications 10, 1 (2021).
- [6] A. Rogalski, Progress in quantum electronics 27, 59 (2003).
- [7] Y. Le Thi, Y. Kamakura, and N. Mori, Japanese Journal of Applied Physics 58, 044002 (2019).
- [8] P. Klipstein, Y. Benny, Y. Cohen, N. Fraenkel, R. Fraenkel, S. Gliksman, A. Glozman, I. Hirsch, O. Klin, L. Langof, et al., in *Infrared Technology and Applications XLVII* (SPIE, 2021), vol. 11741, pp. 102–112.
- [9] J. Wróbel, P. Martyniuk, E. Plis, P. Madejczyk, W. Gawron, S. Krishna, and A. Rogalski, in *Infrared Technology and Applications XXXVIII* (SPIE, 2012), vol. 8353, pp. 412–420.
- [10] N. Gautam, H. Kim, M. Kutty, E. Plis, L. Dawson, and S. Krishna, Applied Physics Letters 96, 231107 (2010).
- [11] G. A. Sai-Halasz, L. Esaki, and W. A. Harrison, Phys. Rev. B 18, 2812 (1978).
- [12] T. Manyk, K. Michalczewski, K. Murawski, K. Grodecki, J. Rutkowski, and P. Martyniuk, Results in Physics 11, 1119 (2018).
- [13] A. Rogalski, P. Martyniuk, and M. Kopytko, Progress in Quantum Electronics 68, 100228 (2019).
- [14] D. Chow, R. Miles, J. Schulman, D. Collins, and T. McGill, Semiconductor Science and Technology 6, C47 (1991).
- [15] E. A. Plis, Advances in Electronics **2014** (2014).
- [16] P. Martyniuk, J. Antoszewski, M. Martyniuk, L. Faraone, and A. Rogalski, Applied Physics Reviews 1, 041102 (2014).
- [17] S. Safa, A. Asgari, and L. Faraone, Journal of Applied Physics 114, 053712 (2013).
- [18] S. Safa and A. Asgari, arXiv preprint arXiv:1502.02449 (2015).
- [19] S. Safa and A. Asgari, arXiv preprint arXiv:1502.01453 (2015).
- [20] S. Safa and A. Asgari, arXiv preprint arXiv:1504.02871 (2015).
- [21] F. Szmulowicz, H. Haugan, S. Elhamri, and G. Brown, Physical Review B 84, 155307 (2011).
- [22] F. Szmulowicz and G. Brown, Applied Physics Letters 98, 182105 (2011).
- [23] F. Szmulowicz and G. Brown, Journal of Applied Physics 113, 014302 (2013).

todetectors.

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- [24] G. Bastard, Physical Review B 24, 5693 (1981).
- [25] E. Conwell and V. Weisskopf, Physical review 77, 388 (1950).
- [26] J. D. Zook, Physical Review 136, A869 (1964).
- [27] K. Kaasbjerg, K. S. Thygesen, and A.-P. Jauho, Physical Review B 87, 235312 (2013).
- [28] T.-Y. Tsai, K. Michalczewski, P. Martyniuk, C.-H. Wu, and Y.-R. Wu, Journal of Applied Physics **127**, 033104 (2020).
- [29] M. Wataya, N. Sawaki, H. Goto, I. Akasaki, H. Kano, and M. Hashimoto, Japanese Journal of Applied Physics 28, 1934 (1989).
- [30] I. Dharssi, P. Butcher, and G. Warren, Superlattices and microstructures 9, 335 (1991).
- [31] I. Dharssi and P. Butcher, Journal of Physics: condensed matter 2, 4629 (1990).
- [32] D. Rode, Physical Review B 2, 1012 (1970).
- [33] D. Rode, physica status solidi (b) 55, 687 (1973).
- [34] D. Rode, in Semiconductors and semimetals (Elsevier, 1975), vol. 10, pp. 1–89.
- [35] N. W. Ashcroft, N. D. Mermin, et al., Solid state physics.
- [36] N. D. Mermin, Physical Review B 1, 2362 (1970).
- [37] Y. Livneh, P. Klipstein, O. Klin, N. Snapi, S. Grossman, A. Glozman, and E. Weiss, Physical Review B 86, 235311 (2012).
- [38] P. Klipstein, Physical Review B 81, 235314 (2010).
- [39] C. Ricciardi, M. L. Della Rocca, and M. Benfante (2020).
- [40] P.-F. Qiao, S. Mou, and S. L. Chuang, Optics express 20, 2319 (2012).
- [41] P. Klipstein, Y. Livneh, O. Klin, S. Grossman, N. Snapi, A. Glozman, and E. Weiss, Infrared Physics & Technology 59, 53 (2013).
- [42] D. E. Aspnes and A. Studna, Physical review B 27, 985 (1983).
- [43] S. Datta, Quantum transport: atom to transistor (Cambridge university press, 2005).
- [44] T. Garwood, N. A. Modine, and S. Krishna, Infrared Physics & Technology 81, 27 (2017).
- [45] Y. Wei and M. Razeghi, Physical Review B 69, 085316 (2004).
- [46] R. Nucho and A. Madhukar, Journal of Vacuum Science and Technology 15, 1530 (1978).
- [47] G. C. Dente and M. L. Tilton, Journal of Applied Physics 86, 1420 (1999).
- [48] R. Magri and A. Zunger, Physical Review B 65, 165302 (2002).
- [49] Z. Taghipour, E. Shojaee, and S. Krishna, Journal of Physics: Condensed Matter 30, 325701 (2018).
- [50] G. Bastard, Physical Review B 25, 7584 (1982).
- [51] M. Altarelli, Physical review B 28, 842 (1983).
- [52] E. Kane, in Narrow Gap Semiconductors Physics and Applications (Springer, 1980), pp. 13–31.

- [53] S. L. Chuang, Physics of photonic devices (John Wiley & Sons, 2012).
- [54] Y. Jiang, X. Ma, Y. Xu, and G. Song, Journal of Applied Physics **116**, 173702 (2014).
- [55] N. K. Dhar, R. Dat, and A. K. Sood, Optoelectronics-Advanced Materials and Devices 1 (2013).
- [56] M. Lundstrom, Fundamentals of carrier transport (2002).
- [57] D. K. Ferry, Semiconductor transport (CRC Press, 2016).
- [58] J. Singh, Electronic and optoelectronic properties of semiconductor structures (Cambridge University Press, 2007).
- [59] R. F. Pierret and G. W. Neudeck, Advanced semiconductor fundamentals, vol. 6 (Addison-Wesley Reading, MA, 1987).
- [60] D. Vasileska, S. M. Goodnick, and G. Klimeck, Computational Electronics: semiclassical and quantum device modeling and simulation (CRC press, 2017).
- [61] S. Chakrabarty, A. K. Mandia, B. Muralidharan, S. C. Lee, and S. Bhattacharjee, Journal of Physics: Condensed Matter **32**, 135704 (2019).
- [62] A. K. Mandia, B. Muralidharan, J.-H. Choi, S.-C. Lee, and S. Bhattacharjee, Computer Physics Communications 259, 107697 (2021).
- [63] A. M. Ganose, J. Park, A. Faghaninia, R. Woods-Robinson, K. A. Persson, and A. Jain, Nature communications 12, 1 (2021).
- [64] H. Brooks, in Advances in electronics and electron physics (Elsevier, 1955), vol. 7, pp. 85–182.
- [65] A. Faghaninia, J. W. Ager III, and C. S. Lo, Physical Review B 91, 235123 (2015).

- [66] K. Kothari and M. Maldovan, Scientific Reports 7, 1 (2017).
  [67] H. Sakaki, T. Noda, K. Hirakawa, M. Tanaka, and
- T. Matsusue, Applied physics letters **51**, 1934 (1987). [68] A. Gold, Physical Review B **35**, 723 (1987).
- [08] A. Gold, Physical Review B **35**, (23 (1987)).
- [69] L. Sang, S. Y. Yang, G. P. Liu, G. J. Zhao, C. B. Liu, C. Y. Gu, H. Y. Wei, X. L. Liu, Q. S. Zhu, and Z. G. Wang, IEEE transactions on electron devices **60**, 2077 (2013).
- [70] S. Goodnick, D. Ferry, C. Wilmsen, Z. Liliental, D. Fathy, and O. Krivanek, Physical Review B 32, 8171 (1985).
- [71] A. K. Mandia, N. A. Koshi, B. Muralidharan, S. C. Lee, and S. Bhattacharjee, Journal of Materials Chemistry C (2022).
- [72] Z. Becer, A. Bennecer, and N. Sengouga, Crystals 9, 629 (2019).
- [73] I. Vurgaftman, J. á. Meyer, and L. á. Ram-Mohan, Journal of applied physics 89, 5815 (2001).
- [74] M. Delmas, B. Liang, and D. L. Huffaker, in *Quantum Sensing and Nano Electronics and Photonics XVI* (International Society for Optics and Photonics, 2019), vol. 10926, p. 109260G.
- [75] S. Mitra, Physical Review 132, 986 (1963).
- [76] D. Lockwood, G. Yu, and N. Rowell, Solid State Communications 136, 404 (2005).
- [77] H. Haugan, G. Brown, F. Szmulowicz, and S. Elhamri, in *AIP Conference Proceedings* (American Institute of Physics, 2011), vol. 1416, pp. 155–157.
- [78] R. Alchaar, J.-B. Rodriguez, L. Höglund, S. Naureen, and P. Christol, AIP Advances 9, 055012 (2019).